

# LMV831 Single/ LMV832 Dual/ LMV834 Quad 3.3 MHz Low Power CMOS, EMI Hardened Operational Amplifiers

## General Description

National's LMV831, LMV832, and LMV834 are CMOS input, low power op amp IC's, providing a low input bias current, a wide temperature range of  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  and exceptional performance making them robust general purpose parts. Additionally, the LMV831/LMV832/LMV834 are EMI hardened to minimize any interference so they are ideal for EMI sensitive applications.

The unity gain stable LMV831/LMV832/LMV834 feature 3.3 MHz of bandwidth while consuming only 0.24 mA of current per channel. These parts also maintain stability for capacitive loads as large as 200 pF. The LMV831/LMV832/LMV834 provide superior performance and economy in terms of power and space usage.

This family of parts has a maximum input offset voltage of 1 mV, a rail-to-rail output stage and an input common-mode voltage range that includes ground. Over an operating range from 2.7V to 5.5V the LMV831/LMV832/LMV834 provide a PSRR of 93 dB, and a CMRR of 91 dB. The LMV831 is offered in the space saving 5-Pin SC70 package, the LMV832 in the 8-Pin MSOP and the LMV834 is offered in the 14-Pin TSSOP package.

## Features

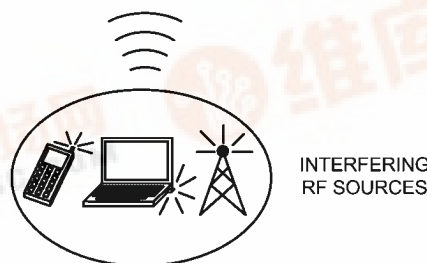
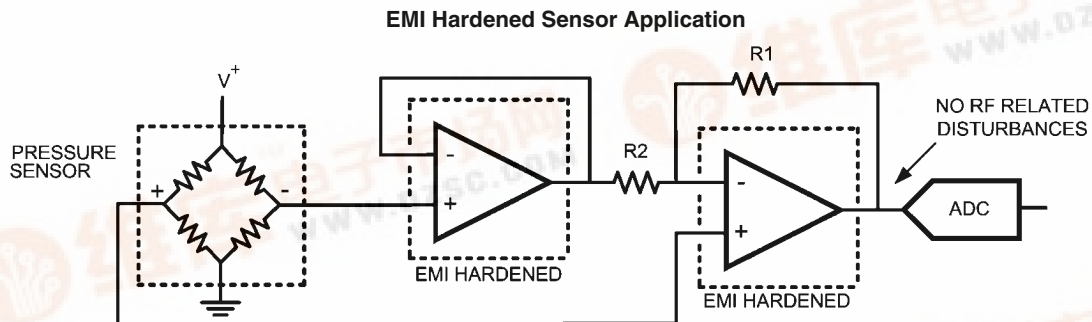
Unless otherwise noted, typical values at  $T_A = 25^{\circ}\text{C}$ ,  $V_+ = 3.3\text{V}$

- Supply voltage 2.7V to 5.5V
- Supply current (per channel) 240  $\mu\text{A}$
- Input offset voltage 1 mV max
- Input bias current 0.1 pA
- GBW 3.3 MHz
- EMIRR at 1.8 GHz 120 dB
- Input noise voltage at 1 kHz 12 nV/ $\sqrt{\text{Hz}}$
- Slew rate 2 V/ $\mu\text{s}$
- Output voltage swing Rail-to-Rail
- Output current drive 30 mA
- Operating ambient temperature range  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$

## Applications

- Photodiode preamp
- Piezoelectric sensors
- Portable/battery-powered electronic equipment
- Filters/buffers
- PDAs/phone accessories

## Typical Application



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**Absolute Maximum Ratings** (Note 1)

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If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

ESD Tolerance (Note 2)

Human Body Model 2 kV

Charge-Device Model 1 kV

Machine Model 200V

 $V_{IN}$  Differential  $\pm$  Supply VoltageSupply Voltage ( $V_S = V^+ - V^-$ ) 6VVoltage at Input/Output Pins  $V^+ + 0.4V$ ,  
 $V^- - 0.4V$ Storage Temperature Range  $-65^\circ\text{C}$  to  $150^\circ\text{C}$ Junction Temperature (Note 3)  $150^\circ\text{C}$ 

Soldering Information

Infrared or Convection (20 sec)  $260^\circ\text{C}$ **Operating Ratings** (Note 1)Temperature Range (Note 3)  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ Supply Voltage ( $V_S = V^+ - V^-$ ) 2.7V to 5.5VPackage Thermal Resistance ( $\theta_{JA}$  (Note 3))5-Pin SC-70  $302^\circ\text{C/W}$ 8-Pin MSOP  $217^\circ\text{C/W}$ 14-Pin TSSOP  $135^\circ\text{C/W}$ **3.3V Electrical Characteristics** (Note 4)Unless otherwise specified, all limits are guaranteed for at  $T_A = 25^\circ\text{C}$ ,  $V^+ = 3.3\text{V}$ ,  $V^- = 0\text{V}$ ,  $V_{CM} = V^+/2$ , and  $R_L = 10\text{ k}\Omega$  to  $V^+/2$ .**Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
$V_{OS}$	Input Offset Voltage (Note 9)			$\pm 0.25$	$\pm 1.00$ <b><math>\pm 1.23</math></b>	mV
$TCV_{OS}$	Input Offset Voltage Temperature Drift (Notes 9, 10)			$\pm 0.5$	$\pm 1.5$	$\mu\text{V}/^\circ\text{C}$
		LMV831, LMV832 LMV834		$\pm 0.5$	$\pm 1.7$	
$I_B$	Input Bias Current (Note 10)			0.1	10 <b>500</b>	pA
$I_{OS}$	Input Offset Current			1		pA
CMRR	Common-Mode Rejection Ratio (Note 9)	$0.2\text{V} \leq V_{CM} \leq V^+ - 1.2\text{V}$	76 <b>75</b>	91		dB
PSRR	Power Supply Rejection Ratio (Note 9)	$2.7\text{V} \leq V^+ \leq 5.5\text{V}$ , $V_{OUT} = 1\text{V}$	76 <b>75</b>	93		dB
EMIRR	EMI Rejection Ratio, IN+ and IN- (Note 8)	$V_{RF\_PEAK} = 100\text{ mV}_P$ ( $-20\text{ dB}_P$ ), $f = 400\text{ MHz}$		80		dB
		$V_{RF\_PEAK} = 100\text{ mV}_P$ ( $-20\text{ dB}_P$ ), $f = 900\text{ MHz}$		90		
		$V_{RF\_PEAK} = 100\text{ mV}_P$ ( $-20\text{ dB}_P$ ), $f = 1800\text{ MHz}$		110		
		$V_{RF\_PEAK} = 100\text{ mV}_P$ ( $-20\text{ dB}_P$ ), $f = 2400\text{ MHz}$		120		
CMVR	Input Common-Mode Voltage Range	CMRR $\geq 65\text{ dB}$	$-0.1$		2.1	V
$A_{VOL}$	Large Signal Voltage Gain (Note 11)	$R_L = 2\text{ k}\Omega$ , $V_{OUT} = 0.15\text{V}$ to $1.65\text{V}$ , $V_{OUT} = 3.15\text{V}$ to $1.65\text{V}$	LMV831, LMV832 LMV834	102 <b>102</b>	121	dB
		$R_L = 10\text{ k}\Omega$ , $V_{OUT} = 0.1\text{V}$ to $1.65\text{V}$ , $V_{OUT} = 3.2\text{V}$ to $1.65\text{V}$	LMV831, LMV832 LMV834	104 <b>104</b>	126	
				104 <b>103</b>	123	

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units	
$V_{OUT}$	Output Voltage Swing High	$R_L = 2\text{ k}\Omega$ to $V^+/2$	LMV831, LMV832		29	36 <b>43</b>	mV from either rail
			LMV834		31	38 <b>44</b>	
		$R_L = 10\text{ k}\Omega$ to $V^+/2$	LMV831, LMV832		6	8 <b>9</b>	
			LMV834		7	9 <b>10</b>	
	Output Voltage Swing Low	$R = 2\text{ k}\Omega$ to $V^+/2$			25	34 <b>43</b>	
		$R_L = 10\text{ k}\Omega$ to $V^+/2$			5	8 <b>10</b>	
$I_{OUT}$	Output Short Circuit Current	Sourcing, $V_{OUT} = V_{CM}$ , $V_{IN} = 100\text{ mV}$	LMV831, LMV832	27 <b>22</b>	28	mA	
			LMV834	24 <b>19</b>	28		
		Sinking, $V_{OUT} = V_{CM}$ , $V_{IN} = -100\text{ mV}$			27 <b>21</b>		32
$I_S$	Supply Current		LMV831		0.24 <b>0.30</b>	mA	
			LMV832		0.46 <b>0.58</b>		
			LMV834		0.90 <b>1.16</b>		
SR	Slew Rate (Note 7)	$A_V = +1$ , $V_{OUT} = 1\text{ V}_{PP}$ , 10% to 90%		2		V/ $\mu$ s	
GBW	Gain Bandwidth Product			3.3		MHz	
$\Phi_m$	Phase Margin			65		deg	
$e_n$	Input Referred Voltage Noise Density	$f = 1\text{ kHz}$		12		$nV/\sqrt{\text{Hz}}$	
		$f = 10\text{ kHz}$		10			
$i_n$	Input Referred Current Noise Density	$f = 1\text{ kHz}$		0.005		$pA/\sqrt{\text{Hz}}$	
$R_{OUT}$	Closed Loop Output Impedance	$f = 2\text{ MHz}$		500		$\Omega$	
$C_{IN}$	Common-mode Input Capacitance			15		pF	
	Differential-mode Input Capacitance			20			
THD+N	Total Harmonic Distortion + Noise	$f = 1\text{ kHz}$ , $A_V = 1$ , $BW \geq 500\text{ kHz}$		0.02		%	

## 5V Electrical Characteristics (Note 4)

Unless otherwise specified, all limits are guaranteed for at  $T_A = 25^\circ\text{C}$ ,  $V^+ = 5\text{V}$ ,  $V^- = 0\text{V}$ ,  $V_{CM} = V^+/2$ , and  $R_L = 10\text{ k}\Omega$  to  $V^+/2$ .

**Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
$V_{OS}$	Input Offset Voltage (Note 9)			$\pm 0.25$	$\pm 1.00$ <b><math>\pm 1.23</math></b>	mV
$TCV_{OS}$	Input Offset Voltage Temperature Drift (Notes 9, 10)	LMV831, LMV832		$\pm 0.5$	$\pm 1.5$	$\mu\text{V}/^\circ\text{C}$
		LMV834		$\pm 0.5$	$\pm 1.7$	
$I_B$	Input Bias Current (Note 10)			0.1	10 <b>500</b>	pA
$I_{OS}$	Input Offset Current			1		pA
CMRR	Common-Mode Rejection Ratio (Note 9)	$0\text{V} \leq V_{CM} \leq V^+ - 1.2\text{V}$	<b>77</b> <b>77</b>	93		dB

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units	
PSRR	Power Supply Rejection Ratio (Note 9)	$2.7V \leq V_+ \leq 5.5V$ , $V_{OUT} = 1V$	76 <b>75</b>	93		dB	
EMIRR	EMI Rejection Ratio, IN+ and IN- (Note 8)	$V_{RF\_PEAK} = 100 \text{ mV}_P$ (-20 dB <sub>P</sub> ), $f = 400 \text{ MHz}$		80		dB	
		$V_{RF\_PEAK} = 100 \text{ mV}_P$ (-20 dB <sub>P</sub> ), $f = 900 \text{ MHz}$		90			
		$V_{RF\_PEAK} = 100 \text{ mV}_P$ (-20 dB <sub>P</sub> ), $f = 1800 \text{ MHz}$		110			
		$V_{RF\_PEAK} = 100 \text{ mV}_P$ (-20 dB <sub>P</sub> ), $f = 2400 \text{ MHz}$		120			
CMVR	Input Common-Mode Voltage Range	$CMRR \geq 65 \text{ dB}$	-0.1		3.8	V	
$A_{VOL}$	Large Signal Voltage Gain (Note 11)	$R_L = 2 \text{ k}\Omega$ , $V_{OUT} = 0.15V \text{ to } 2.5V$ , $V_{OUT} = 4.85V \text{ to } 2.5V$	LMV831, LMV832	107 <b>106</b>	127	dB	
			LMV834	104 <b>104</b>	127		
		$R_L = 10 \text{ k}\Omega$ , $V_{OUT} = 0.1V \text{ to } 2.5V$ , $V_{OUT} = 4.9V \text{ to } 2.5V$	LMV831, LMV832	107 <b>107</b>	130		
			LMV834	105 <b>104</b>	127		
$V_{OUT}$	Output Voltage Swing High	$R_L = 2 \text{ k}\Omega \text{ to } V^+/2$	LMV831, LMV832		32	42 <b>49</b>	mV from either rail
			LMV834		35	45 <b>52</b>	
		$R_L = 10 \text{ k}\Omega \text{ to } V^+/2$	LMV831, LMV832		6	9 <b>10</b>	
			LMV834		7	10 <b>11</b>	
	Output Voltage Swing Low	$R_L = 2 \text{ k}\Omega \text{ to } V^+/2$			27	43 <b>52</b>	
		$R_L = 10 \text{ k}\Omega \text{ to } V^+/2$			6	10 <b>12</b>	
$I_{OUT}$	Output Short Circuit Current	Sourcing $V_{OUT} = V_{CM}$ $V_{IN} = 100 \text{ mV}$	LMV831, LMV832	59 <b>49</b>	66	mA	
			LMV834	57 45	63		
		Sinking $V_{OUT} = V_{CM}$ $V_{IN} = -100 \text{ mV}$	LMV831, LMV832	50 <b>41</b>	64		
			LMV834	53 41	63		
$I_S$	Supply Current	LMV831		0.25	0.27 <b>0.31</b>	mA	
		LMV832		0.47	0.52 <b>0.60</b>		
		LMV834		0.92	1.02 <b>1.18</b>		
SR	Slew Rate (Note 7)	$A_V = +1$ , $V_{OUT} = 2V_{PP}$ , 10% to 90%		2		V/ $\mu$ s	
GBW	Gain Bandwidth Product			3.3		MHz	
$\Phi_m$	Phase Margin			65		deg	
$e_n$	Input Referred Voltage Noise	$f = 1 \text{ kHz}$		12		nV/ $\sqrt{\text{Hz}}$	
		$f = 10 \text{ kHz}$		10			

Symbol	Parameter	Conditions	Min (Note 6)	Typ (Note 5)	Max (Note 6)	Units
$i_n$	Input Referred Current Noise	$f = 1 \text{ kHz}$		0.005		$\text{pA}/\sqrt{\text{Hz}}$
$R_{\text{OUT}}$	Closed Loop Output Impedance	$f = 2 \text{ MHz}$		500		$\Omega$
$C_{\text{IN}}$	Common-mode Input Capacitance			14		pF
	Differential-mode Input Capacitance			20		
THD+N	Total Harmonic Distortion + Noise	$f = 1 \text{ kHz}, A_V = 1, \text{BW} \geq 500 \text{ kHz}$		0.02		%

**Note 1:** Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics Tables.

**Note 2:** Human Body Model, applicable std. MIL-STD-883, Method 3015.7. Machine Model, applicable std. JESD22-A115-A (ESD MM std. of JEDEC) Field-Induced Charge-Device Model, applicable std. JESD22-C101-C (ESD FICDM std. of JEDEC).

**Note 3:** The maximum power dissipation is a function of  $T_{\text{J(MAX)}}$ ,  $\theta_{\text{JA}}$ , and  $T_{\text{A}}$ . The maximum allowable power dissipation at any ambient temperature is  $P_{\text{D}} = (T_{\text{J(MAX)}} - T_{\text{A}}) / \theta_{\text{JA}}$ . All numbers apply for packages soldered directly onto a PC board.

**Note 4:** Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that  $T_{\text{J}} = T_{\text{A}}$ . No guarantee of parametric performance is indicated in the electrical tables under conditions of internal self-heating where  $T_{\text{J}} > T_{\text{A}}$ .

**Note 5:** Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not guaranteed on shipped production material.

**Note 6:** Limits are 100% production tested at 25°C. Limits over the operating temperature range are guaranteed through correlations using statistical quality control (SQC) method.

**Note 7:** Number specified is the slower of positive and negative slew rates.

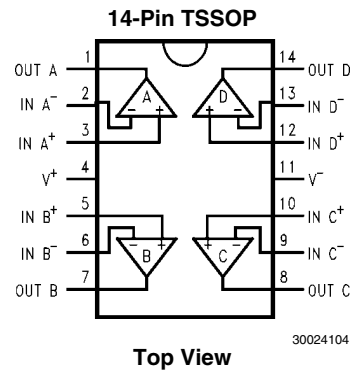
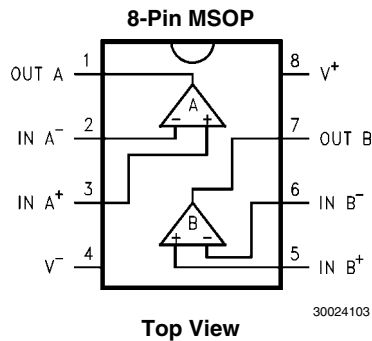
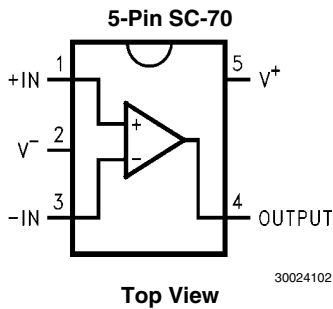
**Note 8:** The EMI Rejection Ratio is defined as  $\text{EMIRR} = 20 \log (V_{\text{RF\_PEAK}} / \Delta V_{\text{OS}})$ .

**Note 9:** The typical value is calculated by applying absolute value transform to the distribution, then taking the statistical average of the resulting distribution.

**Note 10:** This parameter is guaranteed by design and/or characterization and is not tested in production.

**Note 11:** The specified limits represent the lower of the measured values for each output range condition.

## Connection Diagrams

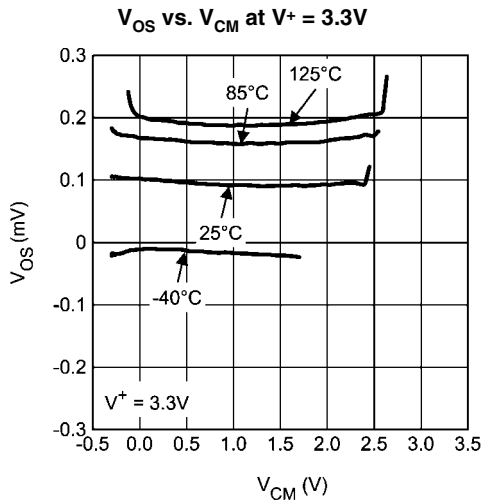


## Ordering Information

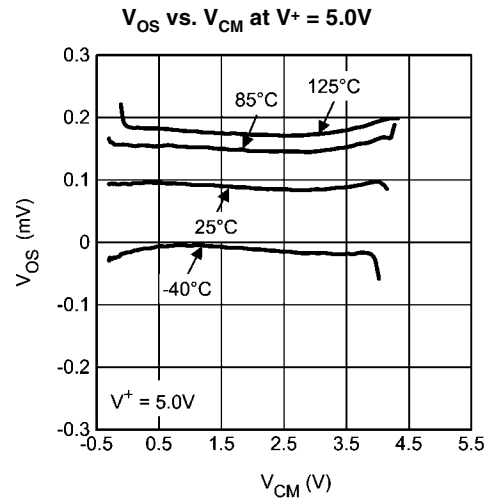
Package	Part Number	Package Marking	Transport Media	NSC Drawing
5-Pin SC-70	LMV831MG	AFA	1k Units Tape and Reel	MAA05A
	LMV831MGE		250 Units Tape and Reel	
	LMV831MGX		3k Units Tape and Reel	
8-Pin MSOP	LMV832MM	AU5A	1k Units Tape and Reel	MUA08A
	LMV832MME		250 Units Tape and Reel	
	LMV832MMX		3.5k Units Tape and Reel	
14-Pin TSSOP	LMV834MT	LMV834MT	94 Units/Rail	MTC14
	LMV834MTX		2.5k Units Tape and Reel	

**Typical Performance Characteristics** At  $T_A = 25^\circ\text{C}$ ,  $R_L = 10\text{ k}\Omega$ ,  $V^+ = 3.3\text{V}$ ,  $V^- = 0\text{V}$ , Unless otherwise specified

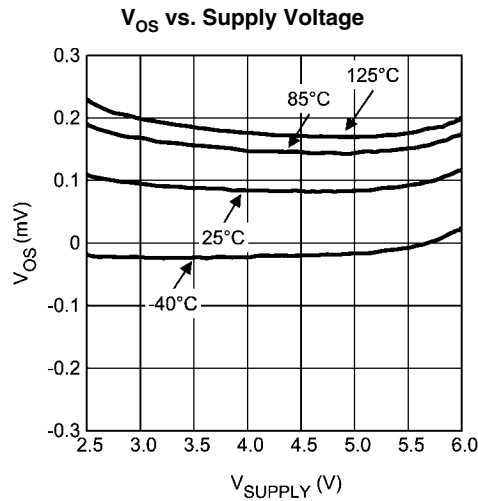
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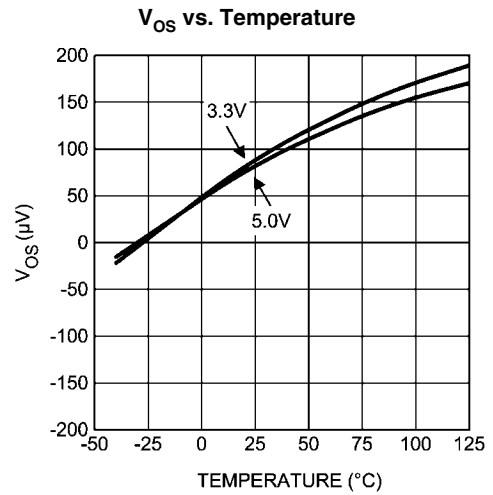
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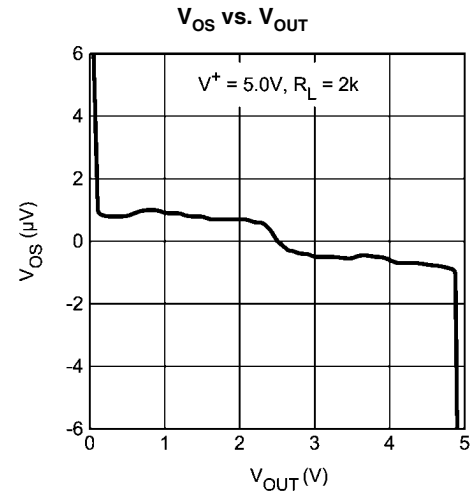
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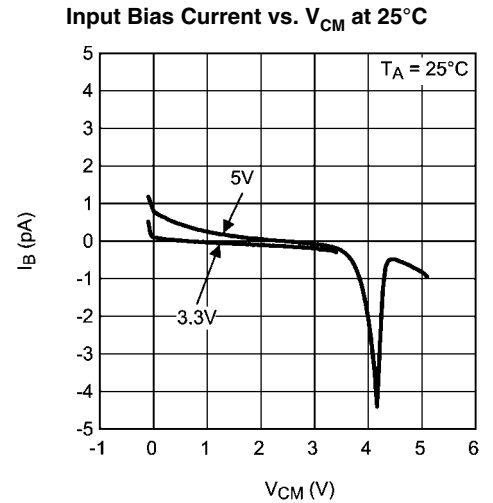
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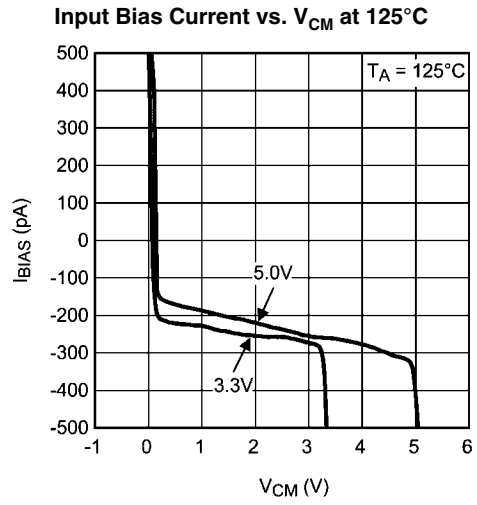
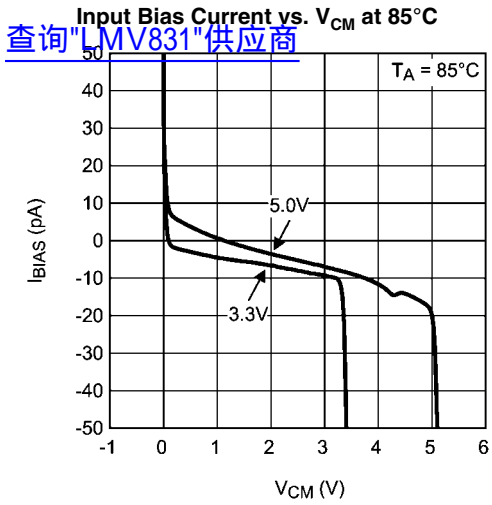
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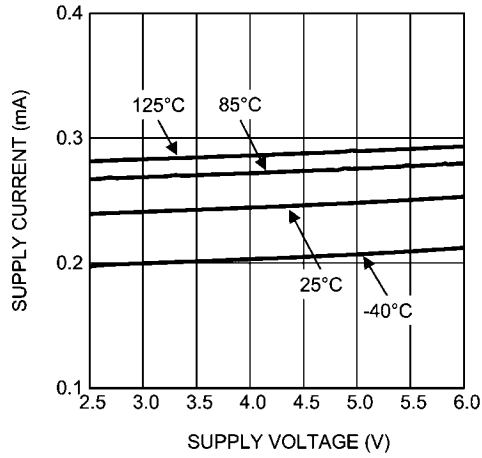
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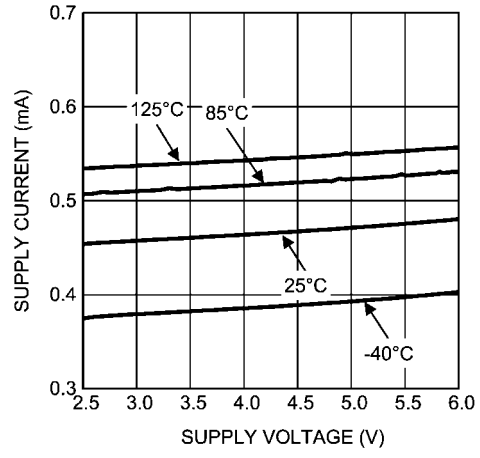
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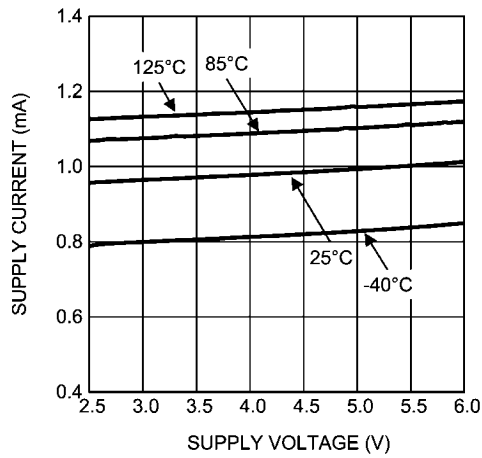
Supply Current vs. Supply Voltage Single LMV831



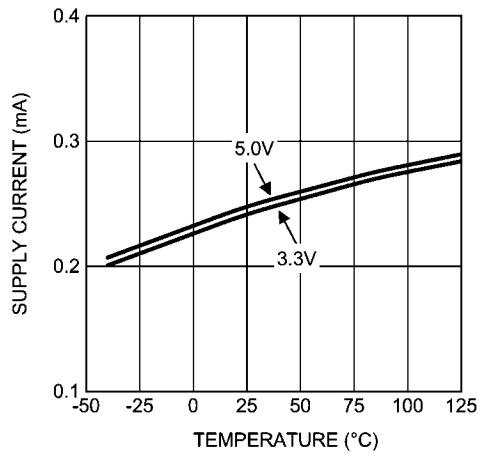
Supply Current vs. Supply Voltage Dual LMV832



Supply Current vs. Supply Voltage Quad LMV834

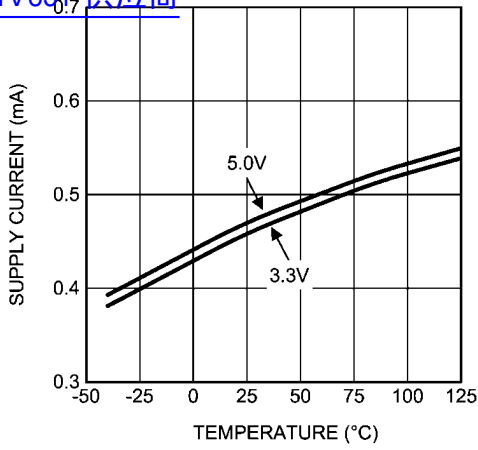


Supply Current vs. Temperature Single LMV831

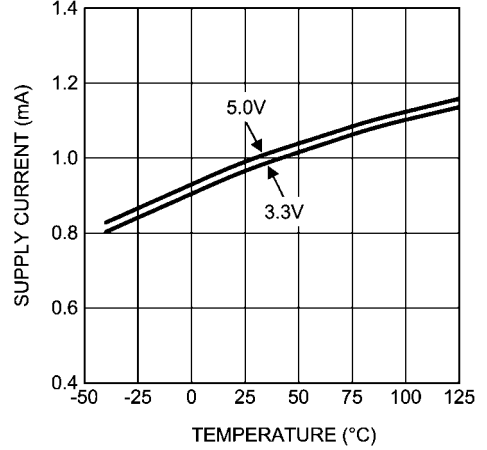


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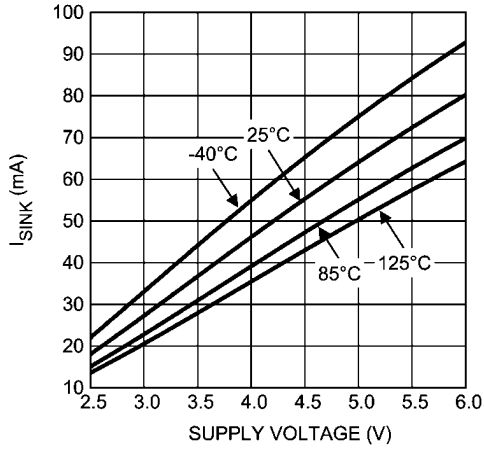
Supply Current vs. Temperature Dual LMV832



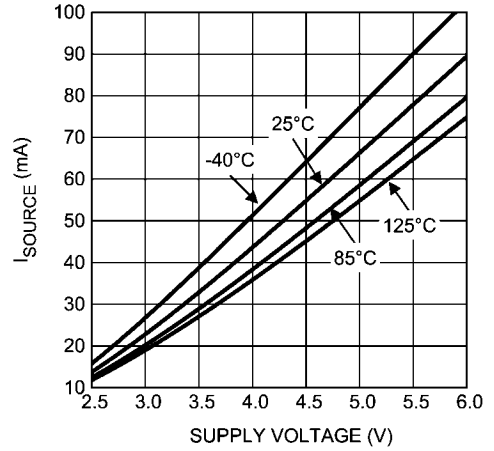
Supply Current vs. Temperature Quad LMV834



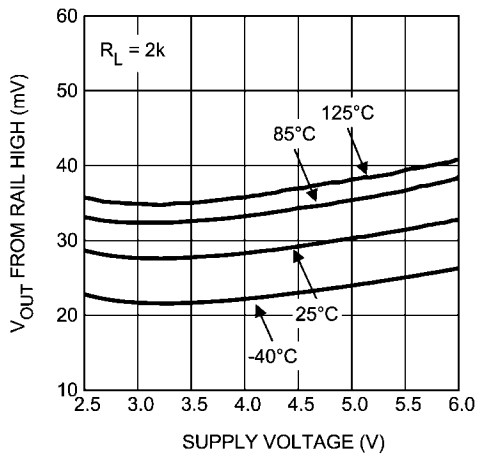
Sinking Current vs. Supply Voltage



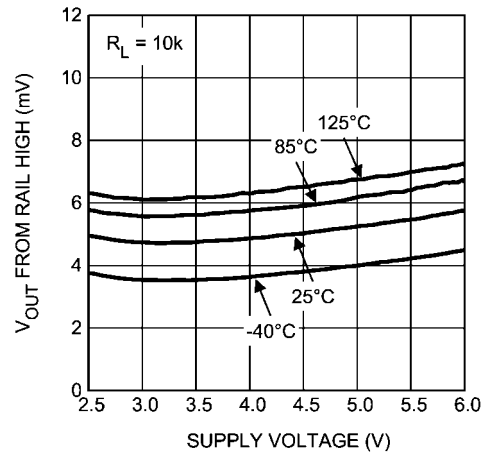
Sourcing Current vs. Supply Voltage



Output Swing High vs. Supply Voltage  $R_L = 2\text{ k}\Omega$



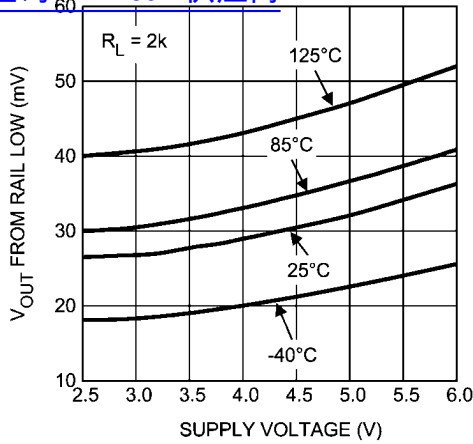
Output Swing High vs. Supply Voltage  $R_L = 10\text{ k}\Omega$





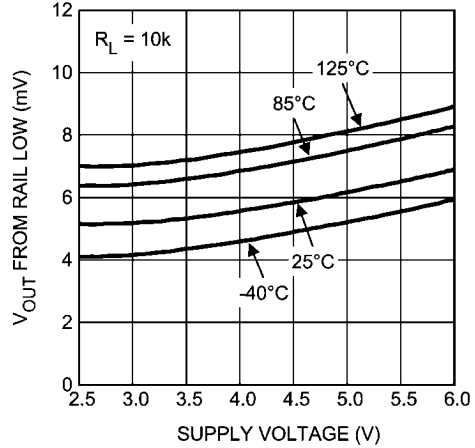
Output Swing Low vs. Supply Voltage  $R_L = 2\text{ k}\Omega$

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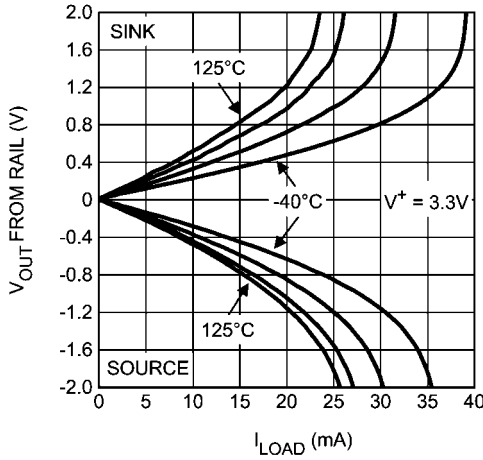
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Output Swing Low vs. Supply Voltage  $R_L = 10\text{ k}\Omega$



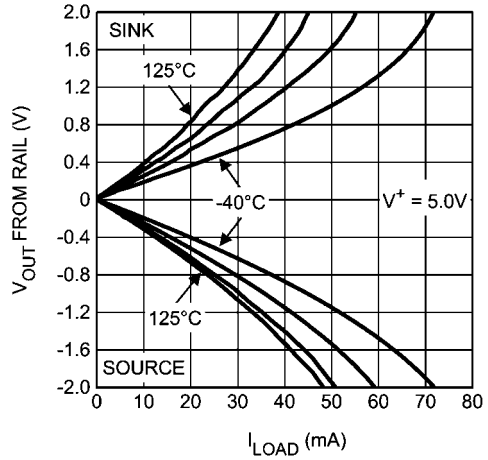
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Output Voltage Swing vs. Load Current at  $V^+ = 3.3\text{V}$



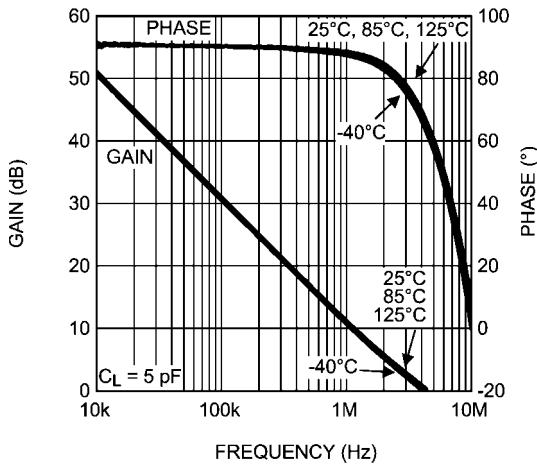
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Output Voltage Swing vs. Load Current at  $V^+ = 5.0\text{V}$



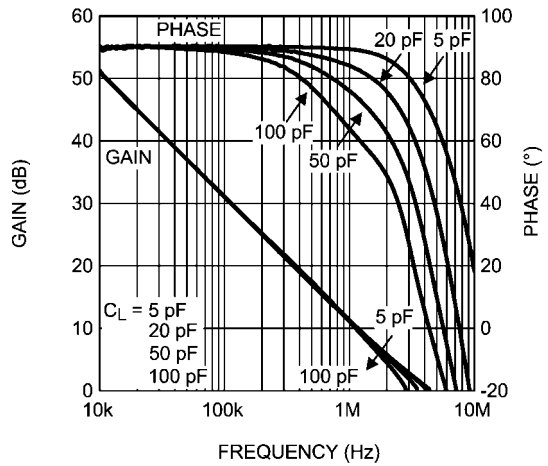
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Open Loop Frequency Response vs. Temperature



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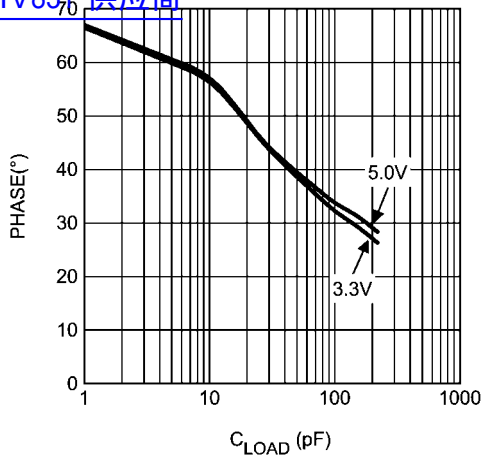
Open Loop Frequency Response vs. Load Conditions



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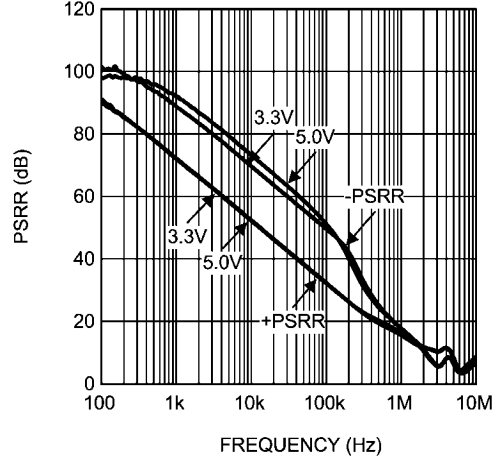
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Phase Margin vs. Capacitive Load



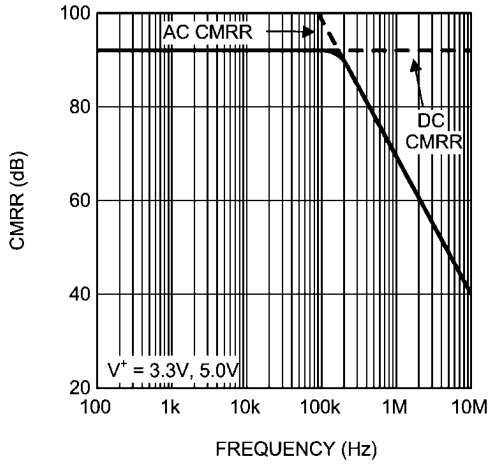
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PSRR vs. Frequency



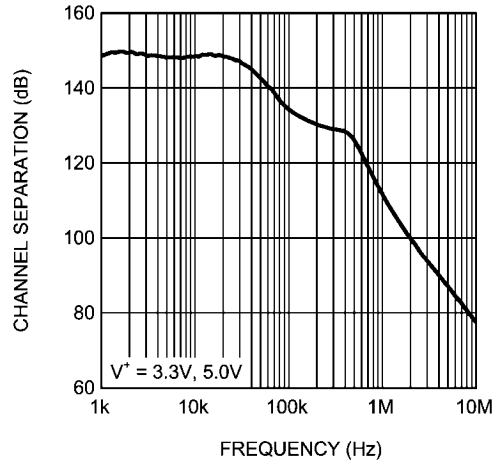
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CMRR vs. Frequency



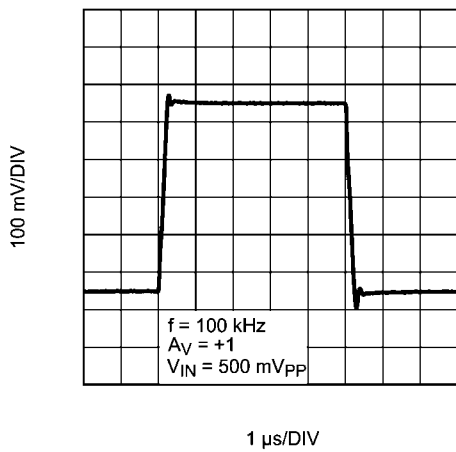
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Channel Separation vs. Frequency



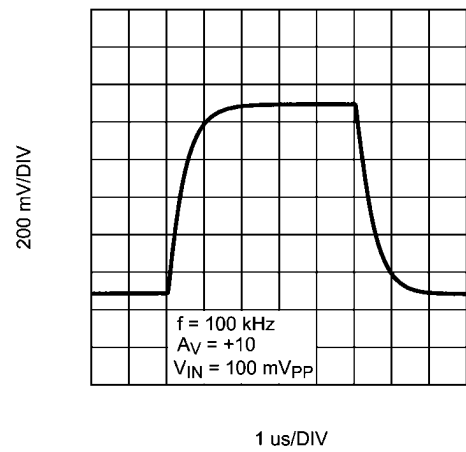
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Large Signal Step Response with Gain = 1



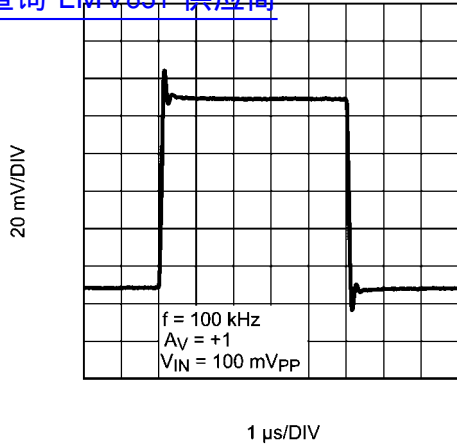
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Large Signal Step Response with Gain = 10



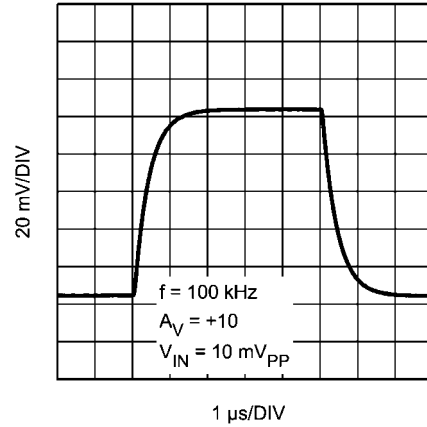
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Small Signal Step Response with Gain = 1  
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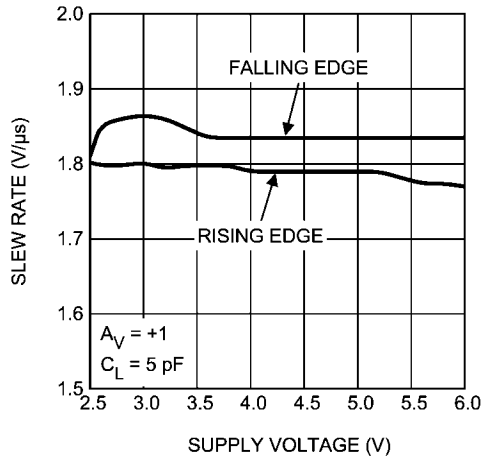
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Small Signal Step Response with Gain = 10



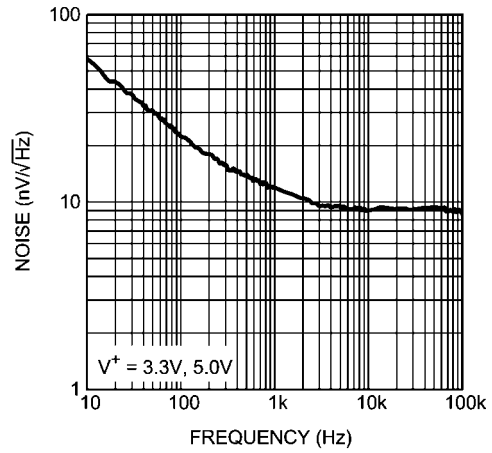
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Slew Rate vs. Supply Voltage



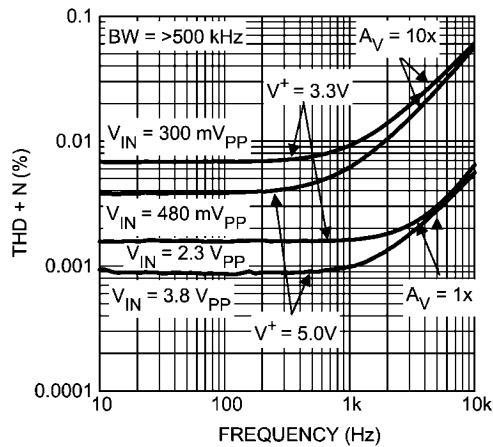
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Input Voltage Noise vs. Frequency



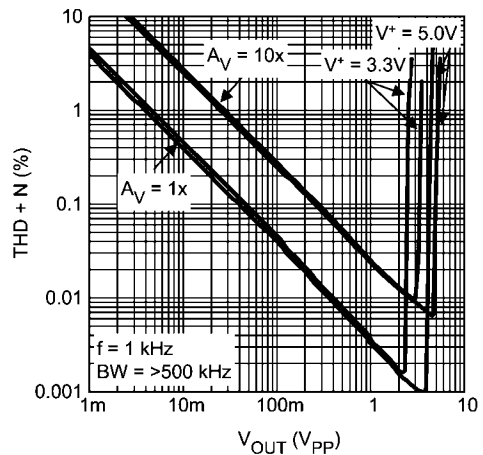
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THD+N vs. Frequency



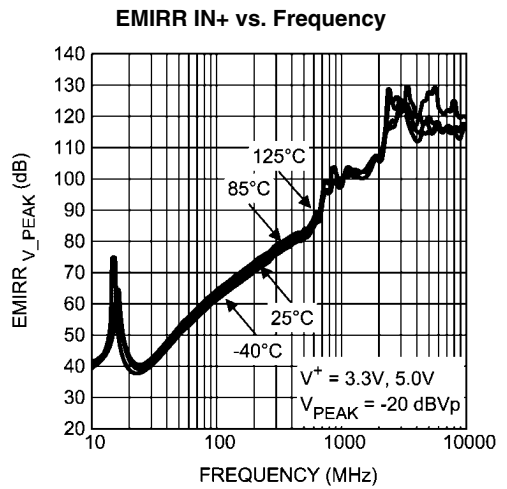
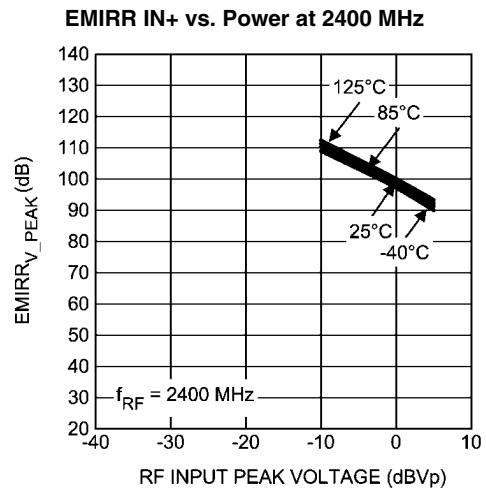
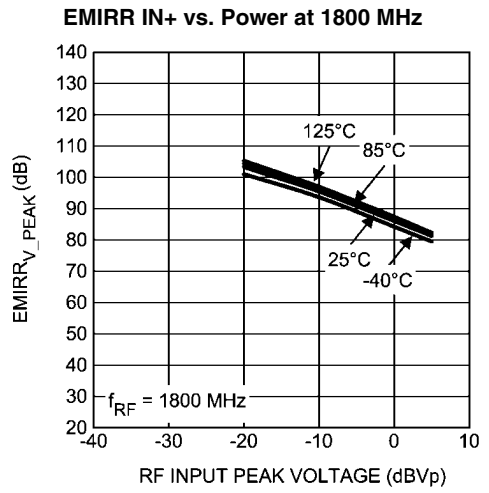
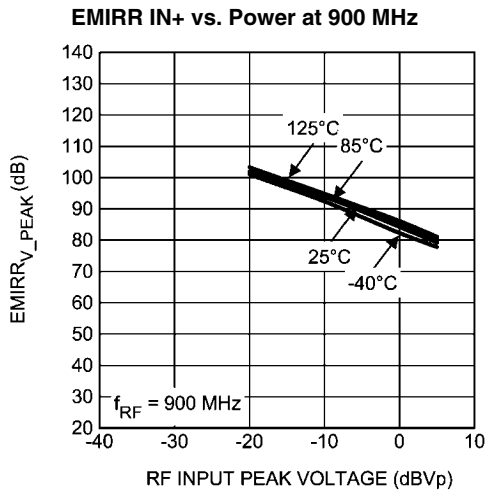
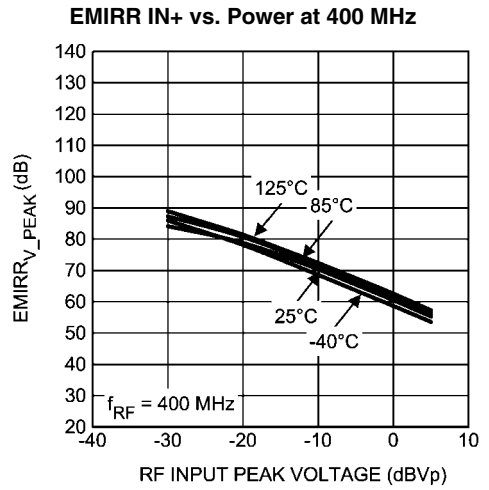
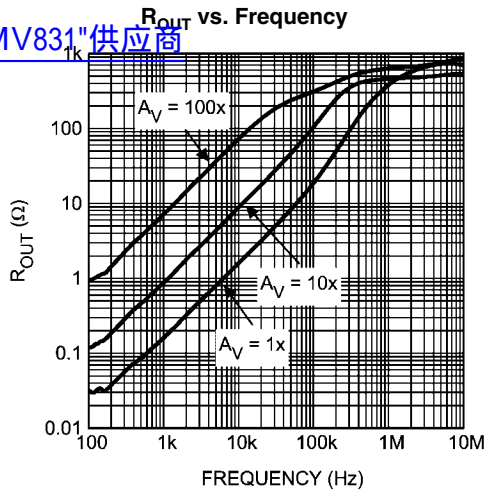
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THD+N vs. Amplitude



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## Application Information

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### INTRODUCTION

The LMV831, LMV832 and LMV834 are operational amplifiers with excellent specifications, such as low offset, low noise and a rail-to-rail output. These specifications make the LMV831, LMV832 and LMV834 great choices for medical and instrumentation applications such as diagnosis equipment. The low supply current is perfectly suited for battery powered equipment. The small packages, SC-70 package for the LMV831, the MSOP package for the dual LMV832 and the TSSOP package for the quad LMV834, make these parts a perfect choice for portable electronics. Additionally, the EMI hardening makes the LMV831, LMV832 or LMV834 a must for almost all op amp applications. Most applications are exposed to Radio Frequency (RF) signals such as the signals transmitted by mobile phones or wireless computer peripherals. The LMV831, LMV832 and LMV834 will effectively reduce disturbances caused by RF signals to a level that will be hardly noticeable. This again reduces the need for additional filtering and shielding. Using this EMI resistant series of op amps will thus reduce the number of components and space needed for applications that are affected by EMI, and will help applications, not yet identified as possible EMI sensitive, to be more robust for EMI.

### INPUT CHARACTERISTICS

The input common mode voltage range of the LMV831, LMV832 and LMV834 includes ground, and can even sense well below ground. The CMRR level does not degrade for input levels up to 1.2V below the supply voltage. For a supply voltage of 5V, the maximum voltage that should be applied to the input for best CMRR performance is thus 3.8V.

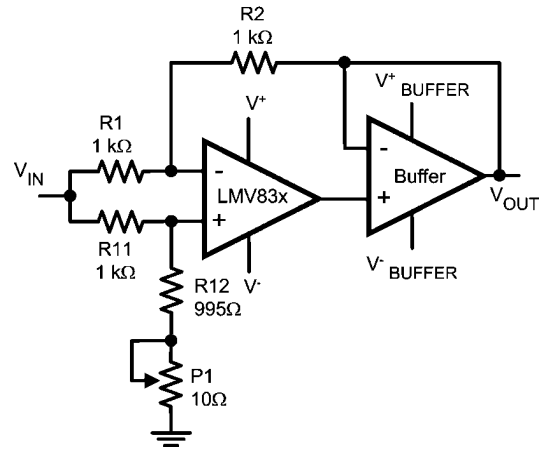
When not configured as unity gain, this input limitation will usually not degrade the effective signal range. The output is rail-to-rail and therefore will introduce no limitations to the signal range.

The typical offset is only 0.25 mV, and the  $TCV_{OS}$  is  $0.5 \mu V/^\circ C$ , specifications close to precision op amps.

### CMRR MEASUREMENT

The CMRR measurement results may need some clarification. This is because different setups are used to measure the AC CMRR and the DC CMRR.

The DC CMRR is derived from  $\Delta V_{OS}$  versus  $\Delta V_{CM}$ . This value is stated in the tables, and is tested during production testing. The AC CMRR is measured with the test circuit shown in *Figure 1*.



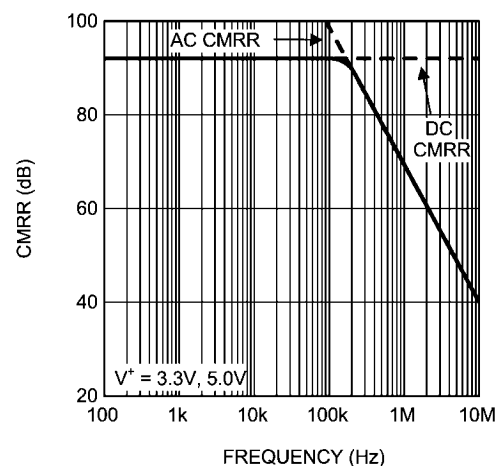
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FIGURE 1. AC CMRR Measurement Setup

The configuration is largely the usually applied balanced configuration. With potentiometer P1, the balance can be tuned to compensate for the DC offset in the DUT. The main difference is the addition of the buffer. This buffer prevents the open-loop output impedance of the DUT from affecting the balance of the feedback network. Now the closed-loop output impedance of the buffer is a part of the balance. As the closed-loop output impedance is much lower, and by careful selection of the buffer also has a larger bandwidth, the total effect is that the CMRR of the DUT can be measured much more accurately. The differences are apparent in the larger measured bandwidth of the AC CMRR.

One artifact from this test circuit is that the low frequency CMRR results appear higher than expected. This is because in the AC CMRR test circuit the potentiometer is used to compensate for the DC mismatches. So, mainly AC mismatch is all that remains. Therefore, the obtained DC CMRR from this AC CMRR test circuit tends to be higher than the actual DC CMRR based on DC measurements.

The CMRR curve in *Figure 2* shows a combination of the AC CMRR and the DC CMRR.



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FIGURE 2. CMRR Curve

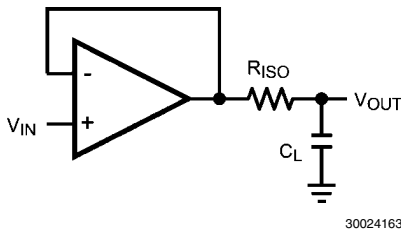
**OUTPUT CHARACTERISTICS**

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As already mentioned, the output is rail-to-rail. When loading the output with a 10 k $\Omega$  resistor the maximum swing of the output is typically 6 mV from the positive and negative rail.

The output of the LMV831/LMV832/LMV834 can drive currents up to 30 mA at 3.3V and even up to 65 mA at 5V

The LMV831/LMV832/LMV834 can be connected as non-inverting unity-gain amplifiers. This configuration is the most sensitive to capacitive loading. The combination of a capacitive load placed at the output of an amplifier along with the amplifier's output impedance creates a phase lag, which reduces the phase margin of the amplifier. If the phase margin is significantly reduced, the response will be under damped which causes peaking in the transfer and, when there is too much peaking, the op amp might start oscillating. The LMV831/LMV832/LMV834 can directly drive capacitive loads up to 200 pF without any stability issues. In order to drive heavier capacitive loads, an isolation resistor, R<sub>ISO</sub>, should be used, as shown in Figure 3. By using this isolation resistor, the capacitive load is isolated from the amplifier's output, and hence, the pole caused by C<sub>L</sub> is no longer in the feedback loop. The larger the value of R<sub>ISO</sub>, the more stable the amplifier will be. If the value of R<sub>ISO</sub> is sufficiently large, the feedback loop will be stable, independent of the value of C<sub>L</sub>. However, larger values of R<sub>ISO</sub> result in reduced output swing and reduced output current drive.



**FIGURE 3. Isolating Capacitive Load**

A resistor value of around 150 $\Omega$  would be sufficient. As an example some values are given in the following table, for 5V.

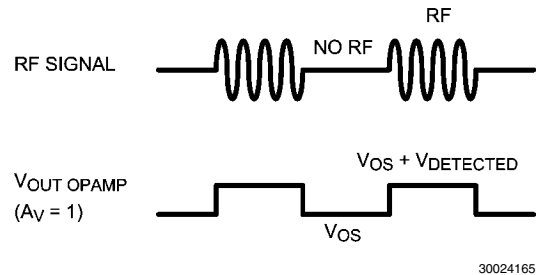
C <sub>LOAD</sub>	R <sub>ISO</sub>
300 pF	165 $\Omega$
400 pF	175 $\Omega$
500 pF	185 $\Omega$

**EMIRR**

With the increase of RF transmitting devices in the world, the electromagnetic interference (EMI) between those devices and other equipment becomes a bigger challenge. The LMV831, LMV832 and LMV834 are EMI hardened op amps which are specifically designed to overcome electromagnetic interference. Along with EMI hardened op amps, the EMIRR parameter is introduced to unambiguously specify the EMI performance of an op amp. This section presents an overview of EMIRR. A detailed description on this specification for EMI hardened op amps can be found in Application Note AN-1698. The dimensions of an op amp IC are relatively small compared to the wavelength of the disturbing RF signals. As a result the op amp itself will hardly receive any disturbances. The RF signals interfering with the op amp are dominantly received by the PCB and wiring connected to the op amp. As a result the RF signals on the pins of the op amp can be represented by voltages and currents. This representation sig-

nificantly simplifies the unambiguous measurement and specification of the EMI performance of an op amp.

RF signals interfere with op amps via the non-linearity of the op amp circuitry. This non-linearity results in the detection of the so called out-of-band signals. The obtained effect is that the amplitude modulation of the out-of-band signal is down-converted into the base band. This base band can easily overlap with the band of the op amp circuit. As an example Figure 4 depicts a typical output signal of a unity-gain connected op amp in the presence of an interfering RF signal. Clearly the output voltage varies in the rhythm of the on-off keying of the RF carrier.



**FIGURE 4. Offset voltage variation due to an interfering RF signal**

**EMIRR DEFINITION**

To identify EMI hardened op amps, a parameter is needed that quantitatively describes the EMI performance of op amps. A quantitative measure enables the comparison and the ranking of op amps on their EMI robustness. Therefore the EMI Rejection Ratio (EMIRR) is introduced. This parameter describes the resulting input-referred offset voltage shift of an op amp as a result of an applied RF carrier (interference) with a certain frequency and level. The definition of EMIRR is given by:

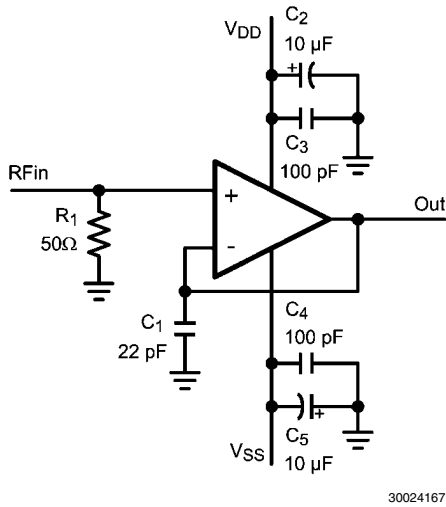
$$EMIRR_{V_{RF\_PEAK}} = 20 \log \left( \frac{V_{RF\_PEAK}}{\Delta V_{OS}} \right)$$

In which V<sub>RF\_PEAK</sub> is the amplitude of the applied un-modulated RF signal (V) and  $\Delta V_{OS}$  is the resulting input-referred offset voltage shift (V). The offset voltage depends quadratically on the applied RF level, and therefore, the RF level at which the EMIRR is determined should be specified. The standard level for the RF signal is 100 mV<sub>p</sub>. Application Note AN-1698 addresses the conversion of an EMIRR measured for an other signal level than 100 mV<sub>p</sub>. The interpretation of the EMIRR parameter is straightforward. When two op amps have an EMIRR which differ by 20 dB, the resulting error signals when used in identical configurations, differ by 20 dB as well. So, the higher the EMIRR, the more robust the op amp.

**Coupling an RF Signal to the IN+ Pin**

Each of the op amp pins can be tested separately on EMIRR. In this section the measurements on the IN+ pin (which, based on symmetry considerations, also apply to the IN- pin) are discussed. In Application Note AN-1698 the other pins of the op amp are treated as well. For testing the IN+ pin the op amp is connected in the unity gain configuration. Applying the RF signal is straightforward as it can be connected directly to the IN+ pin. As a result the RF signal path has a minimum of components that might affect the RF signal level at the pin.

The circuit diagram is shown in *Figure 5*. The PCB trace from  $RF_{IN}$  to the  $IN+$  pin should be a 50 $\Omega$  stripline in order to match the RF impedance of the cabling and the RF generator. On the PCB a 50 $\Omega$  termination is used. This 50 $\Omega$  resistor is also used to set the bias level of the  $IN+$  pin to ground level. For determining the EMIRR, two measurements are needed: one is measuring the DC output level when the RF signal is off; and the other is measuring the DC output level when the RF signal is switched on. The difference of the two DC levels is the output voltage shift as a result of the RF signal. As the op amp is in the unity gain configuration, the input referred offset voltage shift corresponds one-to-one to the measured output voltage shift.

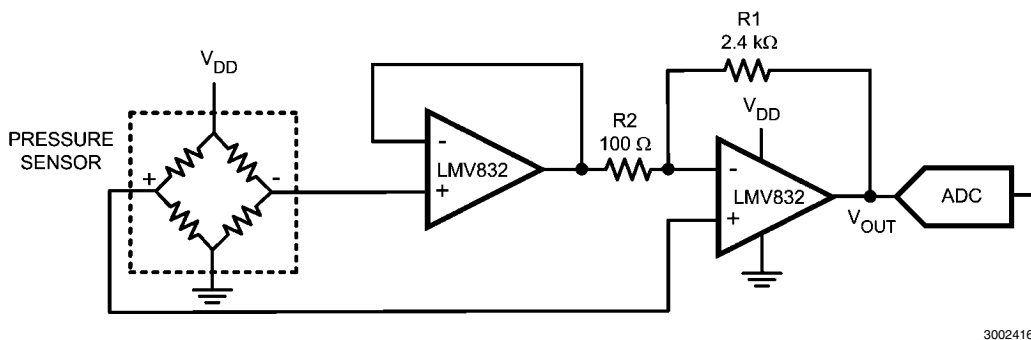


**FIGURE 5. Circuit for coupling the RF signal to IN+**

**Cell Phone Call**

The effect of electromagnetic interference is demonstrated in a setup where a cell phone interferes with a pressure sensor application. The application is shown in *Figure 7*.

This application needs two op amps and therefore a dual op amp is used. The op amp configured as a buffer and con-



**FIGURE 7. Pressure Sensor Application**

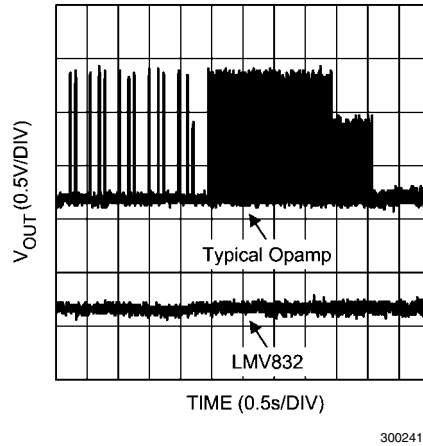
**DECOUPLING AND LAYOUT**

Care must be given when creating a board layout for the op amp. For decoupling the supply lines it is suggested that 10 nF capacitors be placed as close as possible to the op amp. For single supply, place a capacitor between  $V+$  and  $V-$ . For dual supplies, place one capacitor between  $V+$  and the board ground, and a second capacitor between ground and  $V-$ .

ected at the negative output of the pressure sensor prevents the loading of the bridge by resistor R2. The buffer also prevents the resistors of the sensor from affecting the gain of the following gain stage. The op amps are placed in a single supply configuration.

The experiment is performed on two different dual op amps: a typical standard op amp and the LMV832, EMI hardened dual op amp. A cell phone is placed on a fixed position a couple of centimeters from the op amps in the sensor circuit.

When the cell phone is called, the PCB and wiring connected to the op amps receive the RF signal. Subsequently, the op amps detect the RF voltages and currents that end up at their pins. The resulting effect on the output of the second op amp is shown in *Figure 6*.



**FIGURE 6. Comparing EMI Robustness**

The difference between the two types of dual op amps is clearly visible. The typical standard dual op amp has an output shift (disturbed signal) larger than 1V as a result of the RF signal transmitted by the cell phone. The LMV832, EMI hardened op amp does not show any significant disturbances. This means that the RF signal will not disturb the signal entering the ADC when using the LMV832.

Even with the LMV831/LMV832/LMV834 inherent hardening against EMI, it is still recommended to keep the input traces short and as far as possible from RF sources. Then the RF signals entering the chip are as low as possible, and the remaining EMI can be, almost, completely eliminated in the chip by the EMI reducing features of the LMV831/LMV832/LMV834.

## PRESSURE SENSOR APPLICATION

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LMV831/LMV832/LMV834 can be used for pressure sensor applications. Because of their low power the LMV831/LMV832/LMV834 are ideal for portable applications, such as blood pressure measurement devices, or portable barometers. This example describes a universal pressure sensor that can be used as a starting point for different types of sensors and applications.

### Pressure Sensor Characteristics

The pressure sensor used in this example functions as a Wheatstone bridge. The value of the resistors in the bridge change when pressure is applied to the sensor. This change of the resistor values will result in a differential output voltage, depending on the sensitivity of the sensor and the applied pressure. The difference between the output at full scale pressure and the output at zero pressure is defined as the span of the pressure sensor. A typical value for the span is 100 mV. A typical value for the resistors in the bridge is 5 k $\Omega$ . Loading of the resistor bridge could result in incorrect output voltages of the sensor. Therefore the selection of the circuit configuration, which connects to the sensor, should take into account a minimum loading of the sensor.

### Pressure Sensor Example

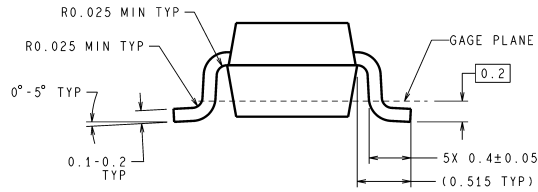
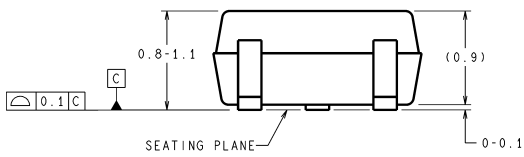
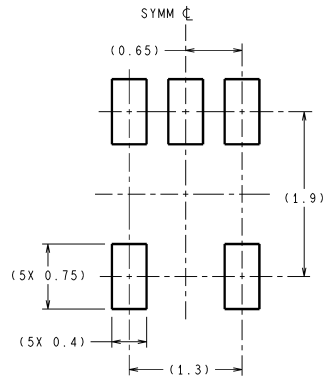
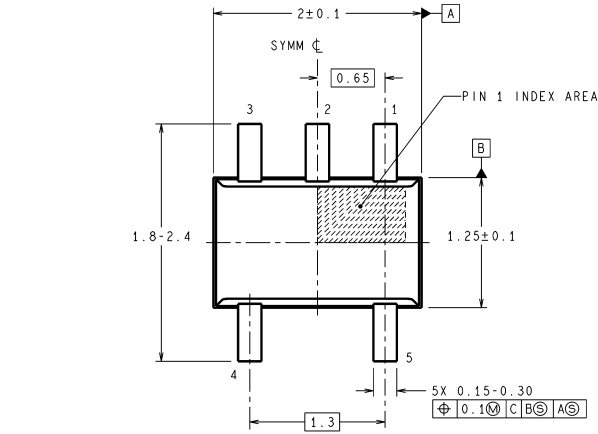
The configuration shown in *Figure 7* is simple, and is very useful for the read out of pressure sensors. With two op amps in this application, the dual LMV832 fits very well. The op amp configured as a buffer and connected at the negative output of the pressure sensor prevents the loading of the bridge by resistor R2. The buffer also prevents the resistors of the sensor from affecting the gain of the following gain stage. Given the differential output voltage  $V_S$  of the pressure sensor, the output signal of this op amp configuration,  $V_{OUT}$ , equals:

$$V_{OUT} = \frac{V_{DD}}{2} - \frac{V_S}{2} \left( 1 + 2 \times \frac{R1}{R2} \right)$$

To align the pressure range with the full range of an ADC, the power supply voltage and the span of the pressure sensor are needed. For this example a power supply of 5V is used and the span of the sensor is 100 mV. When a 100 $\Omega$  resistor is used for R2, and a 2.4 k $\Omega$  resistor is used for R1, the maximum voltage at the output is 4.95V and the minimum voltage is 0.05V. This signal is covering almost the full input range of the ADC. Further processing can take place in the microprocessor following the ADC.



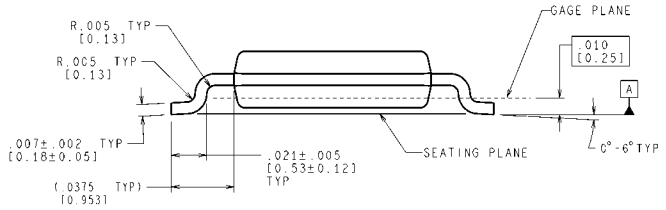
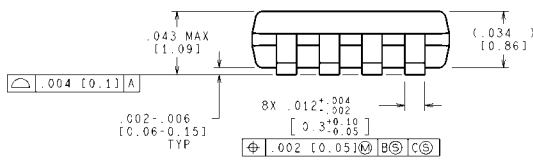
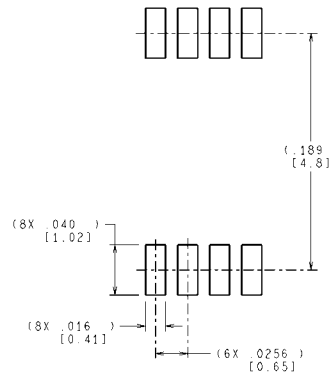
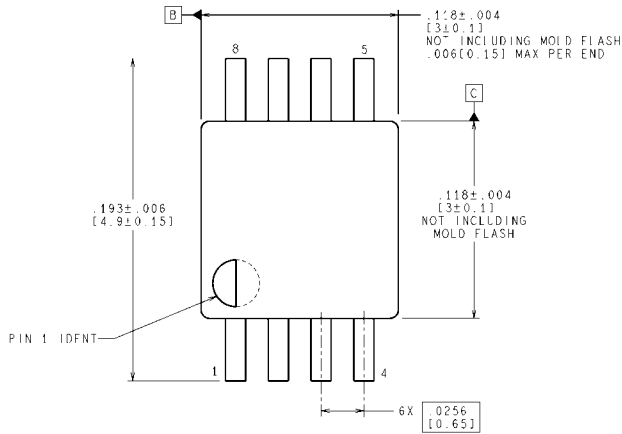
**Physical Dimensions** inches (millimeters) unless otherwise noted  
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MAA05A (Rev D)

**5-Pin SC-70  
 NS Package Number MAA05A**

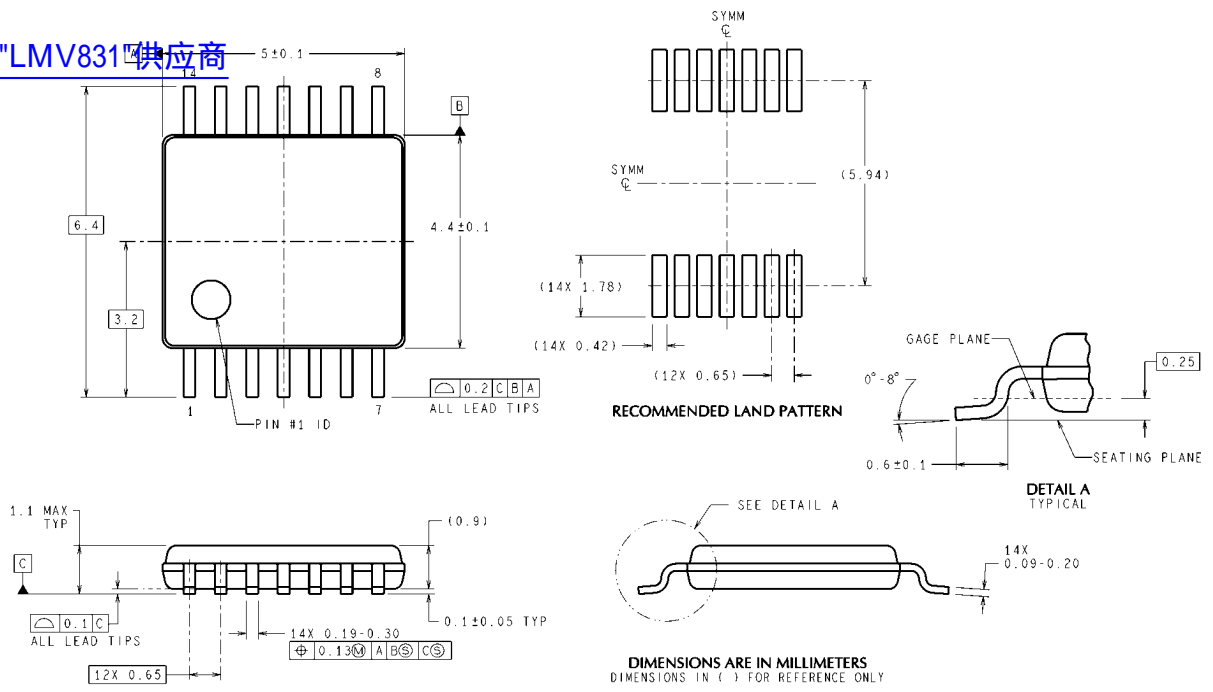


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MUA08A (Rev F)

**8-Pin MSOP  
 NS Package Number MUA08A**

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**14-Pin TSSOP  
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MTC14 (Rev D)

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LDOs	<a href="http://www.national.com/lido">www.national.com/lido</a>		
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PowerWise	<a href="http://www.national.com/powerwise">www.national.com/powerwise</a>		
Serial Digital Interface (SDI)	<a href="http://www.national.com/sdi">www.national.com/sdi</a>		
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Life support devices or systems are devices which (a) are intended for surgical implant into the body, or (b) support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in a significant injury to the user. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system or to affect its safety or effectiveness.

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